



## Material Declaration Datasheet Restriction on Hazardous Substances (RoHS) Compliance

Manufacturer: Intel Corporation

Date: Jan 29, 2015

Equipment type: NUC Motherboard

Product Codes: **xNUC5i5RYHx**, where x may be any combination of alphanumeric character or a blank space

### RoHS Definitions:

Quantity limit of 0.1% by mass (1,000 ppm) for: Lead (Pb); Mercury; Hexavalent Chromium; Polybrominated Biphenyls (PBB); Polybrominated Diphenyl Ethers (PBDE). Quantity limit of 0.010% by mass (100 ppm) for Cadmium.

Intel understands RoHS compliance requires Lead and other materials banned in RoHS Directive are either (1) below all applicable substance thresholds as proposed by the EU, or (2) an approved or pending exemption applies. Note - RoHS implementation details are subject to change.

### RoHS Declaration:

This product is RoHS directive compliant but does contain Lead, a RoHS restricted substance per the definitions above. This product uses the following applicable RoHS technology exemptions: **6(c), 7(a), 7(c)-I**

This product has been verified to be in conformance with EU directive 2011/65/EU as currently understood. To the best of our knowledge the information contained in this declaration is true and correct.

### Level A Materials and Substances:

This product does contain materials listed in Annex A of the EIA/EICTA/JGPSSI Material Composition Declaration Guide above the threshold level of 1,000 ppm as listed below:

Lead/Lead Compounds.

### Level B Materials and Substances:

This product does not contain materials listed in Annex B of the EIA/EICTA/JGPSSI Material Composition Declaration Guide above the threshold level of 1,000 ppm.

### Batteries:

This product does contain perchlorate above the reportable threshold in California Assembly Bill No. 826 Perchlorate Contamination Prevention Act.

This product has been verified to be in conformance with California Assembly Bill No 826 Perchlorate Contamination Prevention Act. To the best of our knowledge the information contained in this declaration is true and correct.

### COMMENTS

1. The data reported for Level A and B materials and substances are based on analytical testing of a representative sample product. Individual test results may vary due to differences in production and/or sensitivities of analytical testing methods. Data shown reflect analytical testing intended to validate Intel's RoHS compliance systems. Intel's certification of RoHS compliance at the homogenous material level is based on Supplier Declarations of Conformance.
2. This declaration is based on the product specified, with all product skus of this product eligible to be covered by this declaration.
3. Material concentration data in parts per million (ppm) is representative of all product skus within the product family.
4. Material mass can be estimated by multiplying concentration (in ppm) by product weight.
5. The remainder of this product consists of non-reportable metals (i.e., copper, iron, tin), epoxy resin and other non-metal materials.

INTEL ACCEPTS NO DUTY TO UPDATE THIS MDSDS OR TO NOTIFY USERS OF THIS MDSDS OF UPDATES OR CHANGES TO THIS MDSDS. INTEL SHALL NOT BE LIABLE FOR ANY DAMAGES, DIRECT OR INDIRECT, CONSEQUENTIAL OR OTHERWISE, SUFFERED BY USERS OR THIRD

PARTIES AS A RESULT OF THE USERS RELIANCE ON INFORMATION IN THIS MDDS THAT HAS BEEN UPDATED OR CHANGED.



## Material Declaration Data Sheet

### Management Methods on Control of Pollution from Electronic Information Products (China RoHS declaration)

#### 产品中有毒有害物质的名称及含量 Hazardous Substances Table

部件名称 Component Name	有毒有害物质或元素 Hazardous Substance					
	铅 Pb	汞 Hg	镉 Cd	六价铬 Cr (VI)	多溴联苯 PBB	多溴二苯醚 PBDE
固态硬盘 Electronic Module	X	O	O	O	O	O

O：表示该有毒有害物质在该部件所有均质材料中的含量均在 SJ/T 11363-2006 (现由 GB/T 26572-2011 取代) 标准规定的限量要求以下。

O: Indicates that this hazardous substance contained in all homogeneous materials of such component is within the limits specified in SJ/T 11363-2006 (now replaced by GB/T 26572-2011).

X：表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 SJ/T 11363-2006 (现由 GB/T 26572-2011 取代) 标准规定的限量要求。

X: Indicates that the content of such hazardous substance in at least a homogeneous material of such component exceeds the limits specified in SJ/T 11363-2006 (now replaced by GB/T 26572-2011).

对销售之日的所售产品, 本表显示我公司供应链的电子信息产品可能包含这些物质。注意: 在所售产品中可能会也可能不会含有所有所列的部件。

This table shows where these substances may be found in the supply chain of our electronic information products, as of the date of sale of the enclosed product. Note that some of the component types listed above may or may not be a part of the enclosed product.

除非另外特别的标注, 此标志为针对所涉及产品的环保使用期限标志。某些可更换的零部件可能会有一个不同的环保使用期限 (例如, 电池单元模块)。

此环保使用期限只适用于产品在产品手册中所规定的条件下工作。



The Environment-Friendly Use Period (EFUP) for all enclosed products and their parts are per the symbol shown here, unless otherwise marked. Certain field-replaceable parts may have a different EFUP (for example, battery modules) number. The Environment-Friendly Use Period is valid only when the product is operated under the conditions defined in the product manual.